

SPECIFICATION SHEET

KHZ SMD CRYSTALS CASE 3215 2 PADS YR SERIES

SPECIFICATION SHEET NO.	R1102-YR32K76800S004			
ORIGINAL MFG/PART NO	TGS/CCMM 32K768A20-6-40-70TLF/SF32WK32768D61T002/MF3215			
NEXTGEN PART CODE	YR32K76800S004	Indicate This Code For RFQ/Order		
DATE	Nov. 2, 2024			
REVISION	A4	Updated With Most Recent Data		
DESCRIPTION AND	KHz SMD Crystals, Case 3	215, 2 Pads, YR series		
MAIN PARAMETRICS	·	±20ppm, Load Capacitance (CL) 6pF ating Temp. Range -40°C ~+85°C 260°C Max. mpliant		
CUSTOMER				
CUSTOMER PART NUMBER				
CROSS REF. PART NUMBER				
МЕМО				

VENDOR APPROVE

Issued/Checked/Approved







Date: Nov. 2, 2024

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MAIN FEATURE

- SMD Package, L3.2*W1.5*H0.9mm, 2 Pads
- Industry Standard
- Reflow Profile Condition 260 °C Max.
- Operating Temperature Range: -40~+85°C
- Available CL 6pF/7pF/9pF/12.5pF
- Low ESR 70 Kohm Max.
- Offer Quality Alternatives Parts For Major Brand and more
- Moisture Sensitivity Level (MSL) 1 (Unlimited)
- REACH/RoHS/RoHS III Compliant

MAIN APPLICATION

Small Communications Devices And More

ELECTRICAL CHARACTERISTICS

See Page 6 For Different Part Number.

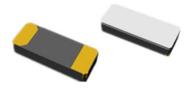


Image shown is a representation only. Exact specifications should be obtained from the product dimension.





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HOW TO ORDER

• Please Follow Up Part Code Guide And Indicate Part Code <u>YR32K76800S004</u> For RFQ/Order.

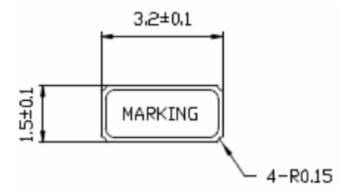
PART CODE GUIDE



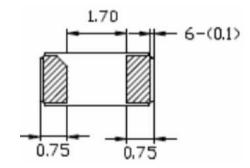
CODE	NAME	KEY SPECIFICATION OPTION
YR	Product Index	KHz SMD Crystal L3.2*W1.5*H0.9mm, 2 Pads
32K768	Frequency Range	32K768: 32.76800KHz
008	Internal Control	Special letter A~Z , a~z or digits (1-9)
004	Parameters	Special Parameters Code letter A~Z, a~z or digits (1-9)
XX	Suffix	Blank: N/A XX: Letter A~Z, a~z or digits (0~9) for Special/Custom Parameters

DIMENSION (Unit: mm)

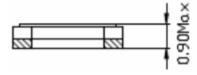
Top View



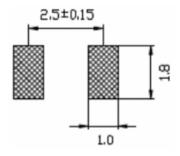
Bottom View

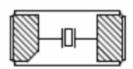


Side View



Land Pattern

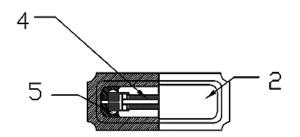


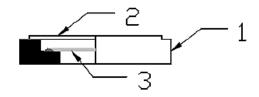




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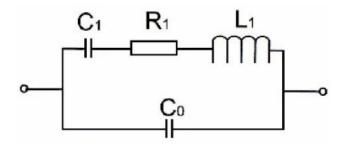
PRODUCT STRUCTURE





Item No.	Component Name	Material Name
1	Crystal Case	Ceramic (A1203)
2	Crystal Cover/Lid	KV (Fe/Co/Ni)
3	Crystal Chip/Blank	SiO2
4	Electrode	Cr, Au (Cr + Au)
5	Adhesive	Resin, Ag

EQUIVALENT CIRCUIT





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ELECTRICAL PARAMETERS – FOR DIFFERENT PART CODE- Ta = 25°C

NEXTGEN	ORIGINAL PART	FREQUENCY RANGE	FREQUENCY	LOAD CAPACITANCE
PART CODE	NUMBER		TOLERANCE	
			@ 25°C±3°C	
		KHz	ppm	pF
YR32K76800S001	SF32WK32768D31T002	32.768	±20	12.5
YR32K76800S003	SF32WK32768D71T005	32.768	±20	7
YR32K76800S004	SF32WK32768D61T002	32.768	±20	6
YR32K76800S005	SF32WK32768D91T004	32.768	±20	9

GENERAL ELECTRICAL PARAMETERS

PARAMETER	UNITS	VALUE			CONDITION
		MIN.	TYPICAL	MAX.	
Mode of Oscillation			AT Fundame	ntal	
Equivalent Series Resistance (ESR)	ΚΩ	-	-	70	
Parabolic Coefficient	ppm/°C²	-0.04	-	-0.02	
Drive Level (DL)	μW	-	0.1	0.5	
Shunt Capacitance (C0)	pF	-	1.1	2.0	
Dynamic Capacitance (C1)	fF	-	4.1	-	
Turnover Temperance	°C	+20	25	+30	
Insulation Resistance	ΜΩ	500			@100Vpc, ± 15VDC
Quality Factor (Q)	К	13	-	-	
Operation Temperance	°C	-40	-	+85	
Storage Temperance	°C	-55	-	+125	
Aging	ppm	-3	-	+3	Per Year

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RELIABILITY

TEST ITEMS	TEST METHOD AND CONDITIONS	TEST STANDARD
High Temperature High Humidity Storage	Temperature: 60°C ± 2 °C Relative Humidity: 90%~95% RH For Time: 500 ± 12 Hours	A, C, D, G
High Temperature Storage	Temperature: 125°C ± 2°C Time: 1000±12 Hours.	В, С, G
Low Temperature Storage	Temperature: -40°C ± 2°C Time: 500 ± 12 Hours.	A, C, G
Temperature Cycle	The crystal unit shall be subjected to 100 successive change of temperature cycles. $ +85+4/-0^{\circ}C $ $ +25\pm2^{\circ}C $ $ -40+0/-6^{\circ}C $ $ 30\pm3\text{min. max.} $ $ 1 \text{ Gycle} $	A, C, G
Solderability	The solder pot temperature is 260±5°C , dwell time 2±0.6sec	F
Drop Test	Height: 180 cm; Dropped Cycle: 3 cycles; Drop it on to a concrete board for 6 Directions (X,Y,Z), that should be 1 cycle	В, С
Vibration	Frequency Range: 10Hz ~ 55Hz Amplitude: 1.5mm±15%; Sweep time: 2~3 Minutes, 2 Hours in each direction, total 6 Hours	А, С
Leakage Test	Helium Bombing 5.0 ~5.5 Kgf/cm²; for 2 hours	E



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TEST ITEMS	TEST METHOD AND CONDITIONS	TEST STANDARD
Terminal Strength	Shall be pressurized at a speed of approx. 0.5mm/sec. in the direction indicated by the arrow unit the bending width reaches 3mm and held for 5 sec. PRESSURE ROD R20 R5 SAMPLE R5 SAMPLE R5	В, С
Sticking Tendency	A R0.5 Jig shall be used to apply a 10N dead load in the direction indicated by the arrow to the element and retain it for 10 sec. JIG R0.5 SAMPLE	В, С
Element Assembly Strength	A RO.5 Jig shall be used to apply a 10N dead load in the direction indicated by the arrow to the element and retain it for 10 sec.	В, С



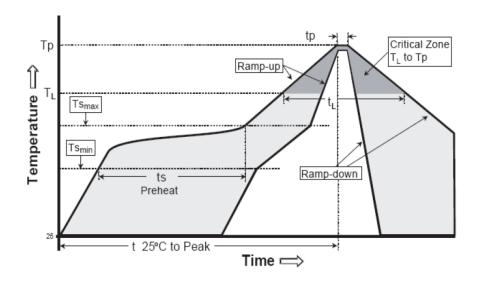
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TEST STANDARD

TEST STANDARD SYMBOL	SPECIFICATION	VALUE
А	Frequency Change permitted	ΔF≤10ppm
В	Frequency Change permitted	ΔF≤20ppm
С	Equivalent Series Resistance Change Permitted	ΔCI≤5KΩ or 20%
D	Insulation Resistance	>500 MΩ
E	Leak Rate Less than	<1*1E-9 Pa • m³/sec.
F	A new uniform coating of solder shall cover a Min 95% of the crystal surface	
G	Then 25 ± 2°C over 2 hours before Testing	

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SUGGESTED REFLOW PROFILE (For Reference No. JEDEC J-STD-020D)



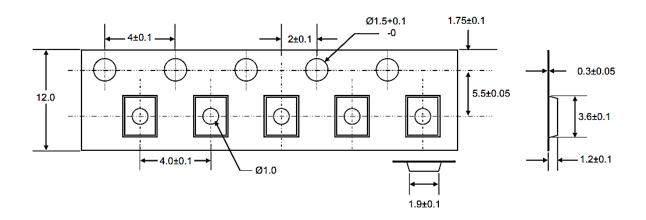
PROFILE FEATURE		PB-FREE ASSEMBLY
Average Ramp-up Rate (Ts Max to Tp)		3°C/second Max
Preheat	Temperature Min (Ts Min.)	150°C
	Temperature Max (Ts Max.)	200°C
	Time (ts Min. to ts Max.)	60 ~ 120 seconds
Time maintained above	Temperature (TL)	217°C
	Time (tL)	60 ~ 150 seconds
Peak/Classification	Temperature (Tp)	260 +/-5°C
Time within 5°C of a	actual Peak Temperature (tp)	20 ~ 40 seconds
Ramp-down rate		6 °C /Second Max.
Time 25 °C to Peak Temperature		8 minutes Max.
Suggest reflow times		3 Times Max.

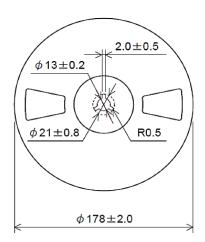
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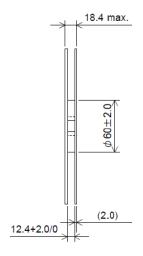
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REEL AND TAPE DIMENSION (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-2 and specifications, 3000pcs/Reel







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NOTES BEFORE USE

Ultrasonic Cleaning

General cleaning solutions or ultrasonic cleaning method may be used to clean our products. However, under certain circumstances, ultrasonic cleaning machine could generate resonance at the oscillation frequency of our products and thus deteriorate the electrical characteristics in device and even damage the overall structure of device. Therefore, verification test is recommended before cleaning.

Ultrasonic Welding

Avoid mounting and processing by Ultrasonic welding this method has a possibility of an excessive vibration spreading inside the crystal products and become the cause of characteristic deterioration and not oscillating.

Storage Temperature Description

Storage Temperature is only for the product itself, the temperature for the packing material is 5~40°C Recommended Conditions for Manual Welding Max. Temperature: 350±10°C, Time: 3 sec Max., Re-solder time: twice Max.

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IMPORTANT NOTES AND DISCLAIMER

- ROHS COMPLIANCE: The levels of RoHS restricted materials in this product are below the maximum
 concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an
 exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for
 this product can be obtained at Download Center.
- REACH COMPLIANCE: REACH substances of high concern (SVHCs) information is available for this product.
 Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained at Download Center.
- 3. All Product parametric performance is indicated in the Electrical Characteristics for the listed herein test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
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